

# MIP0210SP

## Silicon MOS IC

### ■ Features

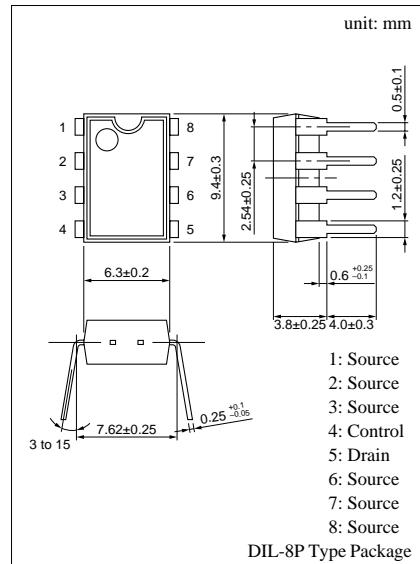
- Single chip IC with high breakdown voltage power MOS FET and CMOS control circuits
- Allowing to input worldwide mains (AC 85 to 274V)
- A pulse-by-pulse overcurrent protection circuit and a timer auto-restart circuit are integrated.

### ■ Applications

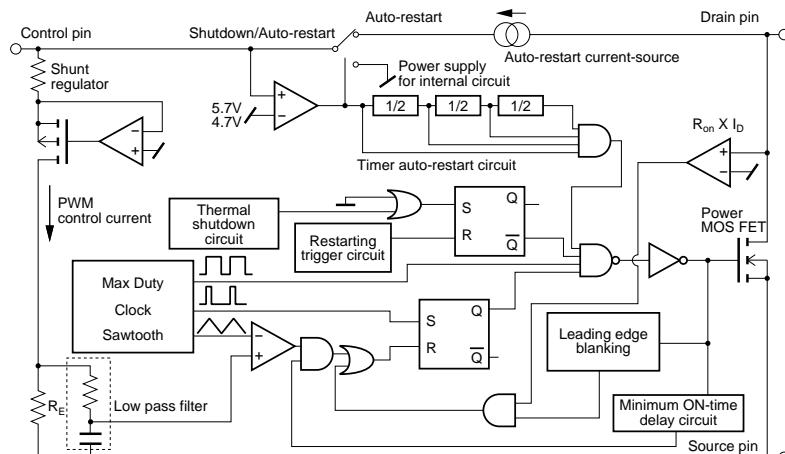
- Switching power supply (to 7W)
- AC adaptor
- Battery charger

### ■ Absolute Maximum Ratings ( $T_a = 25 \pm 3^{\circ}\text{C}$ )

Parameter	Symbol	Ratings	Unit
Drain voltage	$V_D$	700	V
Control voltage	$V_C$	8	V
Output current	$I_D$	1.25	A
Control current	$I_C$	0.1	mA
Channel temperature	$T_{ch}$	150	$^{\circ}\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^{\circ}\text{C}$



### ■ Block Diagram



■ Electrical Characteristics ( $T_C = 25 \pm 2^\circ\text{C}$ )

	Parameter	Symbol	Conditions	min	typ	max	Unit
Control functions	Output frequency	$f_{\text{OSC}}$	$I_C = 2\text{mA}$	90	100	110	kHz
	Maximum duty cycle	MAXDC	$I_C = 2\text{mA}$	64	67	70	%
	Minimum duty cycle	MINDC	$I_C = 10\text{mA}$			3	%
Auto-restart	Control pin charging current	$I_C$	$V_C = 0$	-2.4	-1.9	-1.2	mA
			$V_C = 5\text{V}$	-2	-1.5	-0.8	
	Auto-restart threshold voltage	$V_{C(\text{on})}$		5	5.7	6.3	V
	Lockout threshold voltage	$V_{C(\text{off})}$		4	4.7	5.3	V
	Auto-restart hysteresis voltage	$\Delta V_C$		0.5	1	1.5	V
	Auto-restart duty cycle	$T_{\text{SW}}/T_{\text{TIM}}$			5	8	%
Circuit protection	Auto-restart frequency	$f_{\text{TIM}}$			1.2		Hz
	Self-protection current limit	$I_{\text{LIMIT}}$		0.23	0.29	0.35	A
	Leading edge blanking delay	$t_{\text{on(BLK)}}$	$I_C = 3\text{mA}$		0.25		$\mu\text{s}$
	Current limit delay	$t_{\text{d(OCL)}}$	$I_C = 3\text{mA}$		0.1		$\mu\text{s}$
	Thermal shutdown temperature	$T_{\text{OTP}}$	$I_C = 3\text{mA}$	130	140	150	$^\circ\text{C}$
Output	Power-up reset threshold voltage	$V_{C\text{reset}}$		2.3	3.3	4.2	V
	ON-state resistance	$R_{D\text{S(on)}}$	$I_D = 50\text{mA}$		31	36	$\Omega$
	OFF-state current	$I_{\text{DSS}}$	$V_{\text{DS}} = 650\text{V}$ , Output MOS FET disabled		0.01	0.25	mA
	Breakdown voltage	$V_{\text{DSS}}$	$I_D = 0.25\text{mA}$ , Output MOS FET disabled	700			V
	Rise time	$t_r$			0.1	0.2	$\mu\text{s}$
Power supply voltage	Fall time	$t_f$			0.1	0.2	$\mu\text{s}$
	Drain supply voltage	$V_{D(\text{MIN})}$		36			V
	Shunt regulator voltage	$V_C$	$I_C = 3\text{mA}$	5.5	5.8	6.1	V
	Control supply/discharge current	$I_{CD1}$	Output MOS FET enabled	0.7	1.4	1.8	mA
		$I_{CD2}$	Output MOS FET disabled	0.5	0.8	1.1	mA